

Vishay Siliconix

P-Channel 20 V (D-S) MOSFET

MOSFET PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
- 20	0.112 at V _{GS} = - 4.5 V	- 3.1	3.3 nC			
	0.142 at V _{GS} = - 2.5 V	- 2.7	3.3 110			

FEATURES

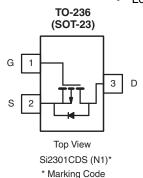
- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

Load Switch







Ordering Information: Si2301CDS-T1-E3 (Lead (Pb)-free) Si2301CDS-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (TA	, = 25 °C, unless otl	herwise noted)		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 20	v	
Gate-Source Voltage		V _{GS}	± 8	V
	T _C = 25 °C		- 3.1	
Continuous Drain Current (T 150 °C)	T _C = 70 °C	, T	- 2.5	
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	- 2.3 ^{b, c}	
	T _A = 70 °C	-	- 1.8 ^{b, c}	A
Pulsed Drain Current		I _{DM}	- 10	
Oradiana Daria Dia In Orazat	T _C = 25 °C	1	- 1.3	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 0.72 ^{b, c}	
	T _C = 25 °C		1.6	
Maximum Dawar Dissinction	T _C = 70 °C	D D	1.0	w
Maximum Power Dissipation	T _A = 25 °C	P _D	0.86 ^{b, c}	vv
	T _A = 70 °C	_	0.55 ^{b, c}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	≤ 5 s	R _{thJA}	120	145	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	62	78	0/11	

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 175 °C/W.

Si2301CDS

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I_D = - 250 μ A	- 20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 ··· A		- 18		- mV/°0	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		2.2			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 0.4		- 1	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0$ V, $V_{GS} = \pm 8$ V			± 100	nA	
Zana Oata Malta na Duain Ourmant		V _{DS} = - 20 V, V _{GS} = 0 V			- 1	μΑ	
Zero Gate Voltage Drain Current	IDSS	V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 55 °C	5°C - 1		- 10		
On-State Drain Current ^a	I _{D(on)}	V_{DS} \leq - 5 V, V_{GS} = - 4.5 V	- 6			Α	
		V_{GS} = - 4.5 V, I _D = - 2.8 A		0.090	0.112	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V_{GS} = - 2.5 V, I _D = - 2.0 A		0.110	0.142		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = -5 \text{ V}, \text{ I}_{D} = -2.8 \text{ A}$		9.5		S	
Dynamic ^b				•	•		
Input Capacitance	C _{iss}			405		pF	
Output Capacitance	C _{oss}	V_{DS} = - 10 V, V_{GS} = 0 V, f = 1 MHz		75			
Reverse Transfer Capacitance	C _{rss}			55			
Tatal Oata Obarra	Qg	V_{DS} = - 10 V, V_{GS} = - 4.5 V, I_D = - 3 A		5.5	10		
Total Gate Charge				3.3	6		
Gate-Source Charge	Q _{gs}	V_{DS} = - 10 V, V_{GS} = - 2.5 V, I_{D} = - 3 A		0.7		- nC	
Gate-Drain Charge	Q _{gd}			1.3			
Gate Resistance	R _g	f = 1 MHz		6.0		Ω	
Turn-On Delay Time	t _{d(on)}			11	20		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 10 Ω		35	60	- ns	
Turn-Off Delay Time	t _{d(off)}	$I_D = -1 \text{ A}, V_{GEN} = -4.5 \text{ V}, \text{ R}_g = 1 \Omega$		30	50		
Fall Time	t _f			10	20		
Drain-Source Body Diode Characteristic	cs						
Continuous Source-Drain Diode Current	۱ _S	$T_{\rm C} = 25 ^{\circ}{\rm C}$			- 1.3		
Pulse Diode Forward Current ^a	I _{SM}				- 10	A (
Body Diode Voltage	V _{SD}	I _S = - 0.7 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			30	50	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			25	50	nC	
Reverse Recovery Fall Time	t _a	$I_F = -3.0 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		15			
Reverse Recovery Rise Time	t _b			15		ns	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

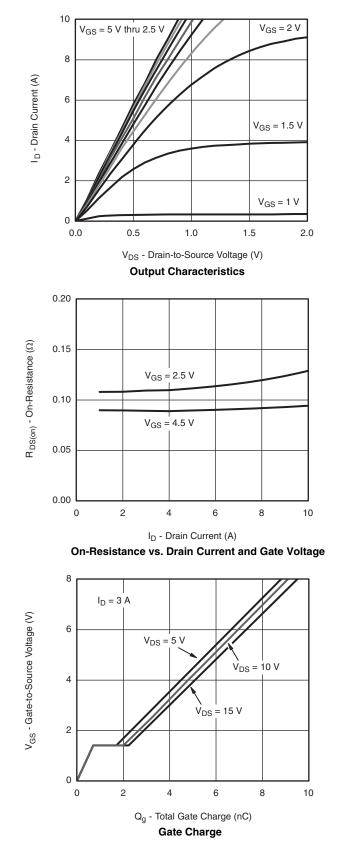
b. Guaranteed by design, not subject to production testing.

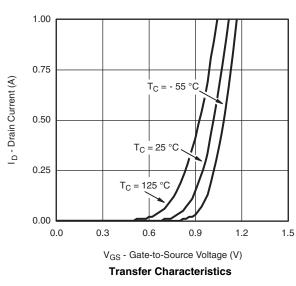
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

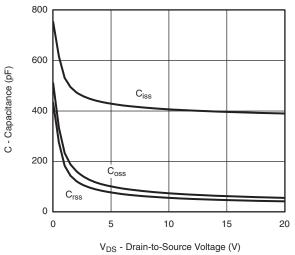


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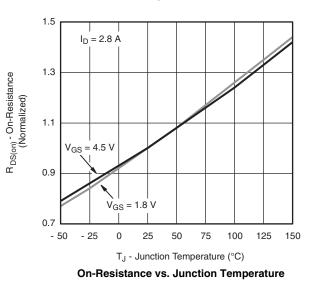
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)











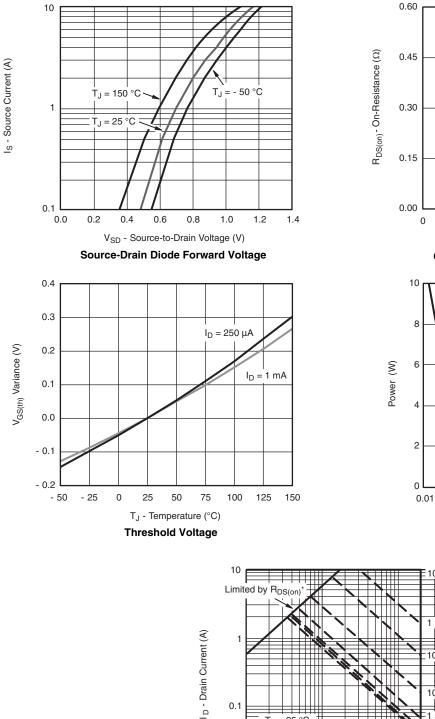
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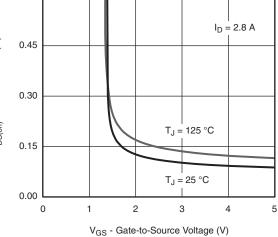
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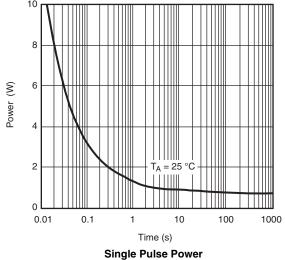


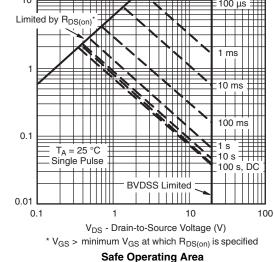
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On-Resistance vs. Gate-to-Source Voltage



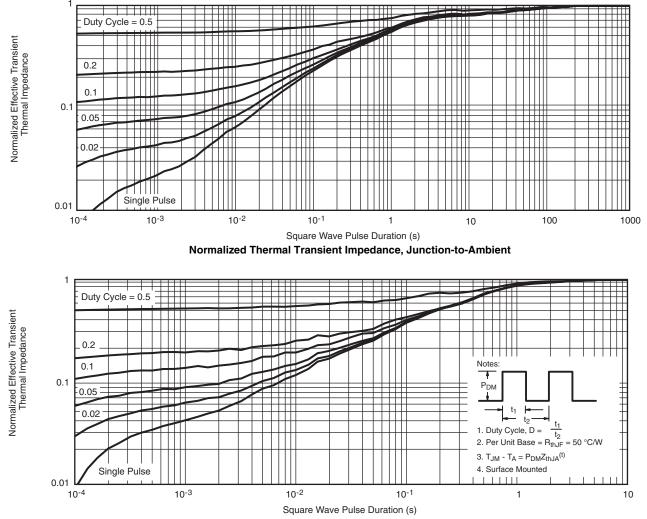


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg268741.



Package Information

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SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	METERS	INCHES			
	Min	Max	Min	Мах		
Α	0.89	1.12	0.035	0.044		
A ₁	0.01	0.10	0.0004	0.004		
A ₂	0.88	1.02	0.0346	0.040		
b	0.35	0.50	0.014	0.020		
С	0.085	0.18	0.003	0.007		
D	2.80	3.04	0.110	0.120		
E	2.10	2.64	0.083	0.104		
E ₁	1.20	1.40	0.047	0.055		
е	0.95 BSC		0.0374 Ref			
e ₁	1.90	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024		
L ₁	0.64 Ref		0.025	5 Ref		
S	0.50 Ref		0.020	0.020 Ref		
q	3°	8°	3°	8°		



Application Note 826

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RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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